N-Channel 40V MOSFET

E040N2P5HL1

V _{DS} (V)	R _{DS(on),max} (mΩ)	I _D (A)
40V	2.5 @ V _{GS} = 10V	125

Features

- Low R_{DS(on)} trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

Applications

- DC/DC conversion
- Power switch
- PD charger
- Moto driver

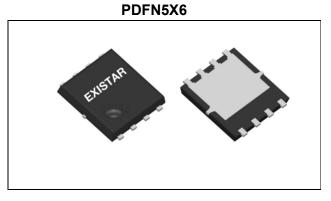
Package And Ordering Information

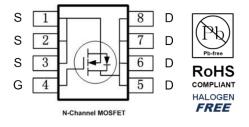
Ordering code	Package	Marking
E040N2P5HL1	PDFN5x6	E040N2P5HL1

Ordering Information

Package	Units/ Reel	Reels/ Inner Box	Units/ Inner Box
PDFN5x6	5000	1	5000









Key Performance Parameters

Parameter	Value	Unit
VDS, min @ Tj(max)	40	V
ID, pulse	435	А
RDS(ON), max @ VGS=10V	2.5	mΩ
Qg	45.5	nC

Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted

Parameter	Symbol	Limit	Unit	
Drain-source voltage		V _{DS}	40	
Gate-source voltage		V _{GS}	±20	V
	T _C =25°C		125	
Continuous drain current	T _C =100°C	I _D	-	
Pulsed drain current		I _{D,pulse}	435	А
Avalanche energy, single pulse		E _{AS}	125	mJ
Dower discipution	Tc=25°C		35.7	
Power dissipation	T _A =25°C	P _D	-	W
Operating junction and storage temperature range	TJ, T _{stg}	-55 to 150	°C	

Thermal Characteristics

Parameter		Symbol	Max.	Uni t
Thermal resistance, junction-to-case	Steady state	Rejc	3.1	
Thermal resistance, junction-to-ambient	Steady state	Reja	62	°C/W

Electrical Characteristics at Tj=25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	
Static							
Drain to source breakdown voltage	V(BR)DSS	40			V	V _{GS} = 0, I _D = 250 μA	
Gate-source threshold voltage	V _G s(th)	1.2		2.3	V	V _{DS} = V _{GS} , I _D = 250 μA	
Gate-body leakage	I _{GSS}			±100	nA	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	
Zero gate voltage drain current	I _{DSS}			1	μA	V _{DS} = 32 V, V _{GS} = 0 V	
Drain-source on-resistance	R⊳s(on)		1.85	2.5	mΩ	V _{GS} = 10 V, I _D = 20 A	
Drain-source on-resistance	R _D s(on)		2.45	3.0	mΩ	V _{GS} = 4.5 V, I _D = 15 A	

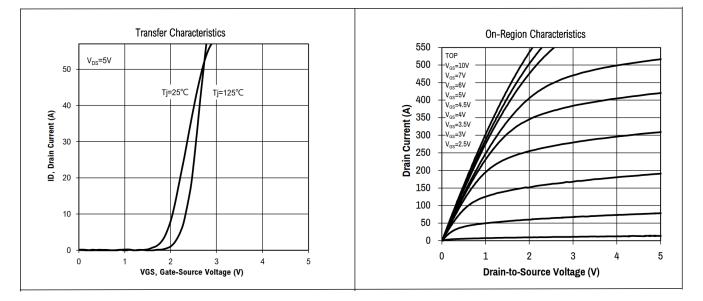




E040N2P5HL1

Forward transconductance	g fs		22		s	V _{DS} = 5 V, I _D = 5 A
Gate resistance	Rg		0.8		Ω	f=1MHz
Gate Charge						
Total gate charge	Qg		45.5			
Gate-source charge	Qgs		9		nC	V_{DS} = 20 V, I_D = 20 A, V_{GS} = 10 V
Gate-drain charge	Qgd		6.6			
		[Dynamic	;		
Turn-on delay time	t _{d(on)}		18.6			
Rise time	tr		45.8		ns	V _{DS} =20 V, I _D =20 A, V _{GS} = 10 V, R _{GEN} = 3.3 Ω
Turn-off delay time	t _{d(off)}		16.6			
Fall time	t _f		7.8			
Input capacitance	C _{iss}		2940			
Output capacitance	C _{oss}		628		pF	V _{DS} =20 V, V _{GS} = 0 V, f = 1MHz
Reverse transfer capacitance	C _{rss}		34			
Body Diode						
Diode forward voltage	Vsd			1.2	V	V _{GS} = 0 V, I _F = 20 A
Reverse recovery time	trr		24		ns	V _R = 20 V, I _S =20 A, di/dt = 100
Reverse recovery charge	Qrr		16		nC	A/µs

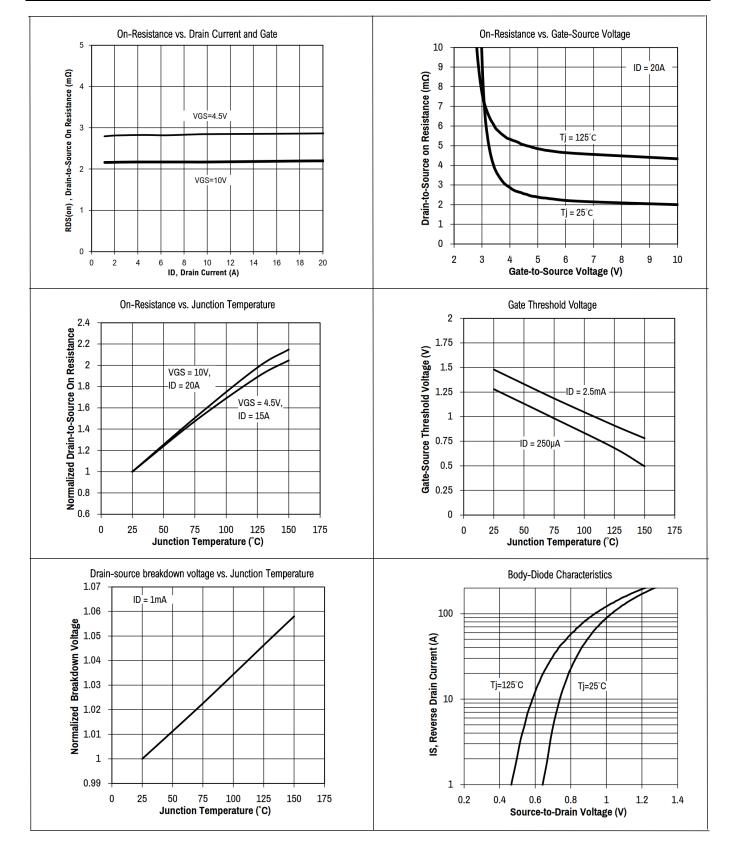
Electrical Characteristics Diagrams







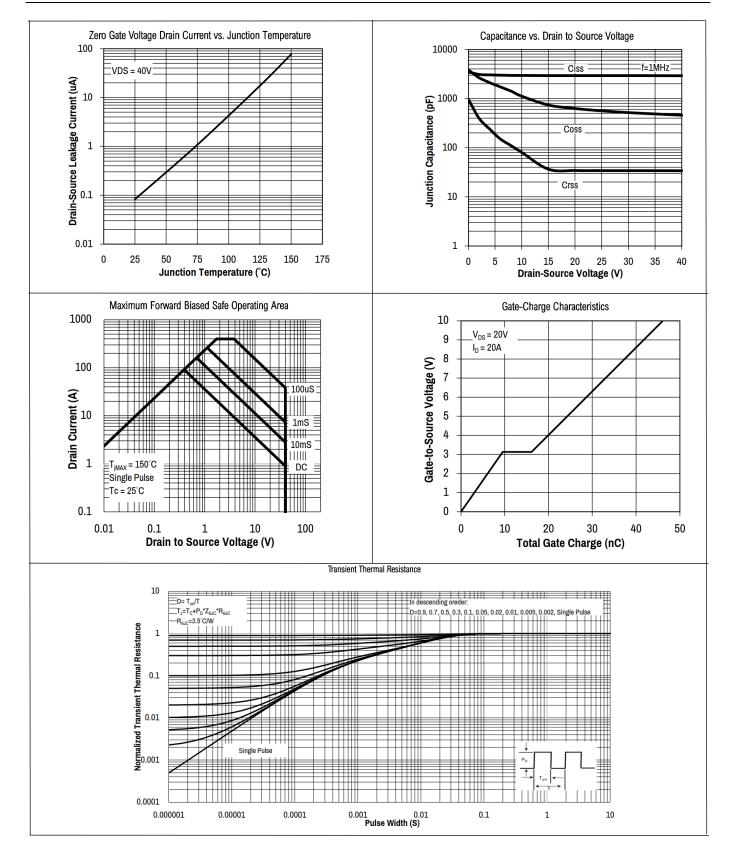
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Test circuits and waveforms

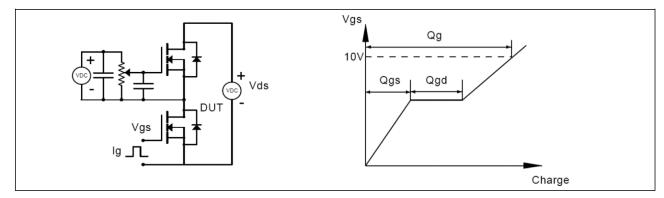


Figure 1. Gate charge test circuit & waveform

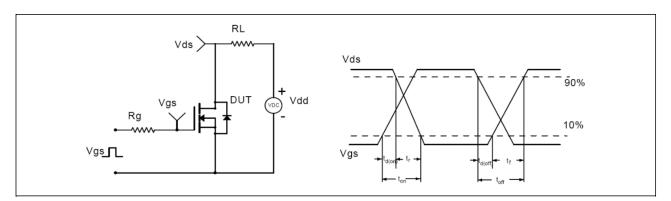
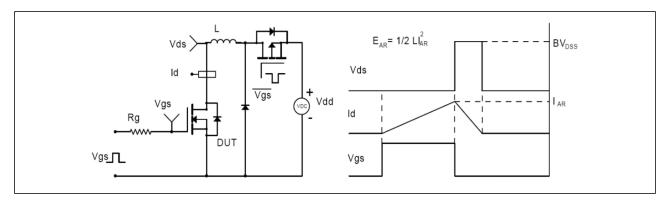


Figure 2. Switching time test circuit & waveforms





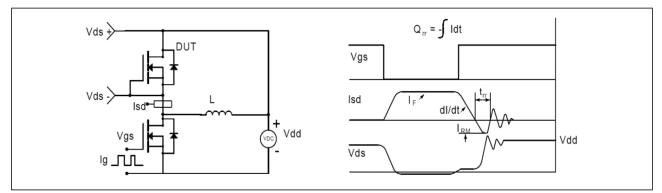
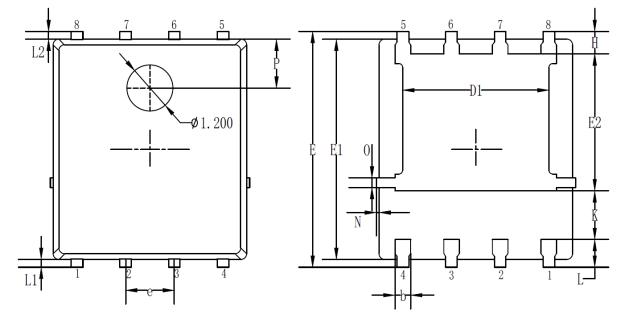


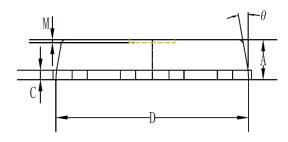
Figure 4. Diode reverse recovery test circuit & waveforms





Package Outline Dimensions





0 1 1	Mil	llimeter	S			
Symbols	MIN.	NOM.	MAX.			
А	0.90	1.05	1.20			
b	0.35	0.40	0.50			
С	0.20	0.25	0.35			
D	4.90	5.05	5.20			
D1	3.72	3.82	3.92			
Е	0.60	6.15	6.30			
E1	5. 60	5.75	5.90			
E2	3.47	3.57	3.67			
е]	1.27 BSC	•			
Н	0.48	0.58	0.68			
К	1.17	1.27	1.37			
L	0.64	0.74	0.84			
L1/L2		0.20 REF	? .			
θ	8°	10°	12°			
М	0.08 REF.					
N	0	_	0.15			
0	0.25 REF.					
Р	1.28 REF.					



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